# SHJ太陽電池における水素起因界面欠陥の発生機構

**布村正太<sup>1</sup>、坂田功<sup>1</sup>、Mickaël Lozac<sup>1</sup>h<sup>2</sup>、松原浩司<sup>3</sup>** 

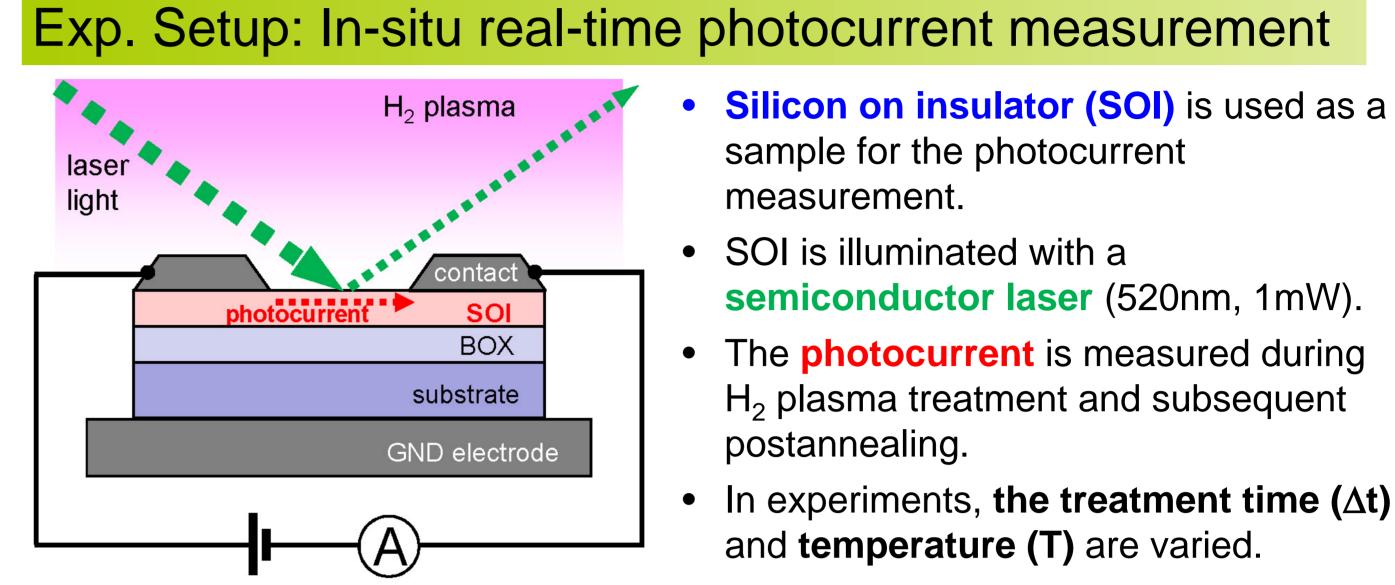
產業技術総合研究所 1電子光基礎技術研究部門、 2デバイス技術研究部門、3エネルギー・環境領域

(mV)

np V<sub>oc</sub>

## Abstract

- Hydrogen plasma-induced defects in crystalline silicon have been studied, by using in-situ photocurrent measurement and spectroscopic ellipsometry.
- A hydrogen (H<sub>2</sub>) plasma treatment causes surface defects, bulk defects and surface disordered layer (DSL), depending on the treatment time.



The defect formation strongly depends on the treatment time & treatment temperature.

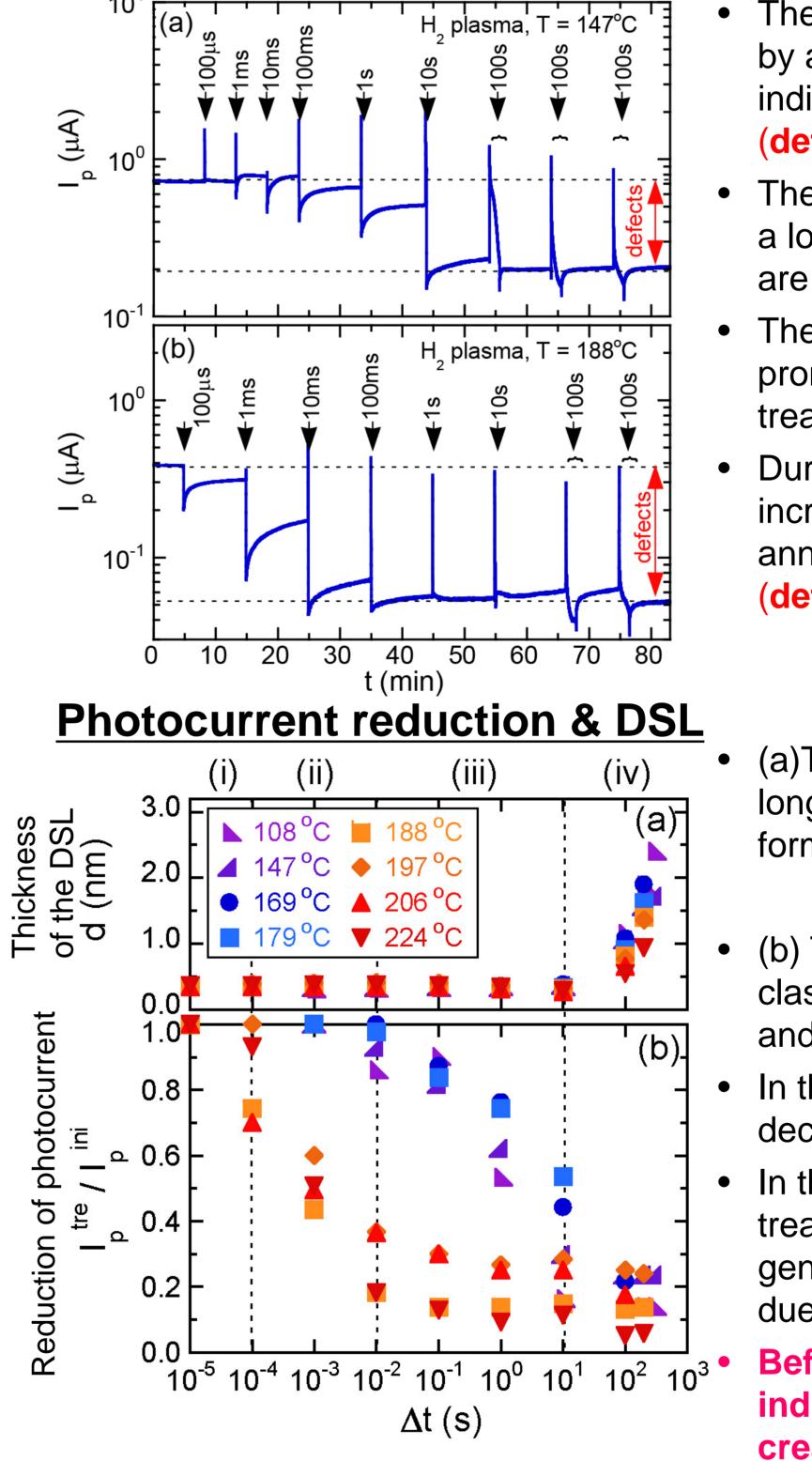
- The **photocurrent** is measured during H<sub>2</sub> plasma treatment and subsequent
- In experiments, the treatment time ( $\Delta t$ )

#### SHJ solar cell structure & minority carrier lifetime Ag contact 10ms 800 1ms TCO 700 /i a-Si:H litetime 100μs 600 10µs impVoc c-Si wafer **b**... (n-type) 1µs 500 ~180µm cleaned with DHF annealing a-Si:H ssivation formation i/n a-Si:H

- $\bullet$ plays important roles in surface passivation & carrier selection.
- The lifetime, i.e., a measure for the surface passivation, varies throughout the fabrication process of SHJ solar cells

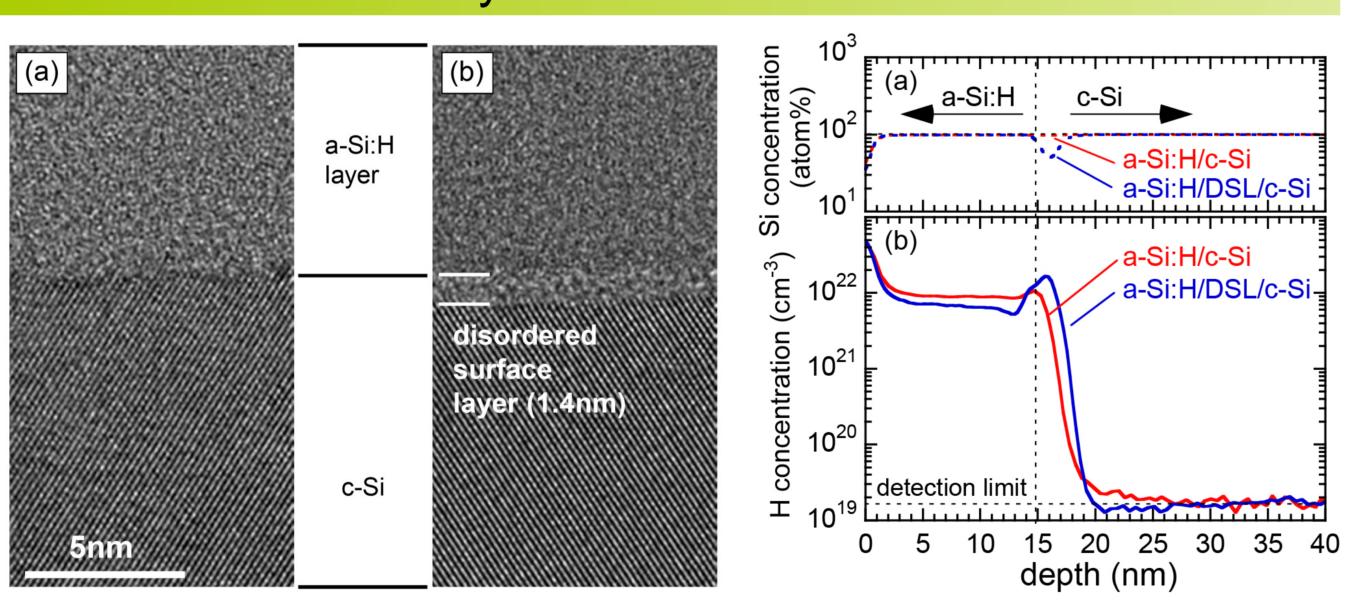
# **Experimental results**

### **Time evolution of photocurrents**



- The photocurrent (I<sub>p</sub>) is reduced by a  $H_2$  plasma treatment, indicating generation of defects (defect generation).
- The reduction of  $I_{p}$  is enhanced for a long- $\Delta t$  treatment; more defects are generated.
- The generation of defects are pronounced for a short- $\Delta t$ treatment under high-T conditions.
- During postannealing,  $I_{p}$  is increased, indicating the annihilation of defects. (defect annihilation)

#### **TEM and SIMS analysis**



- TEM: (a) Normal sharp Interface of a-Si:H/c-Si. (b) Formation of the disordered surface layer (DSL). The DSL is formed by a sufficiently long- $\Delta t$  $H_2$  plasma treatment.
- SIMS: H atoms concentrate at the interface. The concentration is increased at the interface with DSL. S. Nunomura et al., Jpn. J. Appl. Phys. 59, SHHE05 (2020).

S. Nunomura et al., J. Appl. Phys. 128, 033302 (2020).

# Model: Formation of H atom-induced defects & DSL

(a) initial

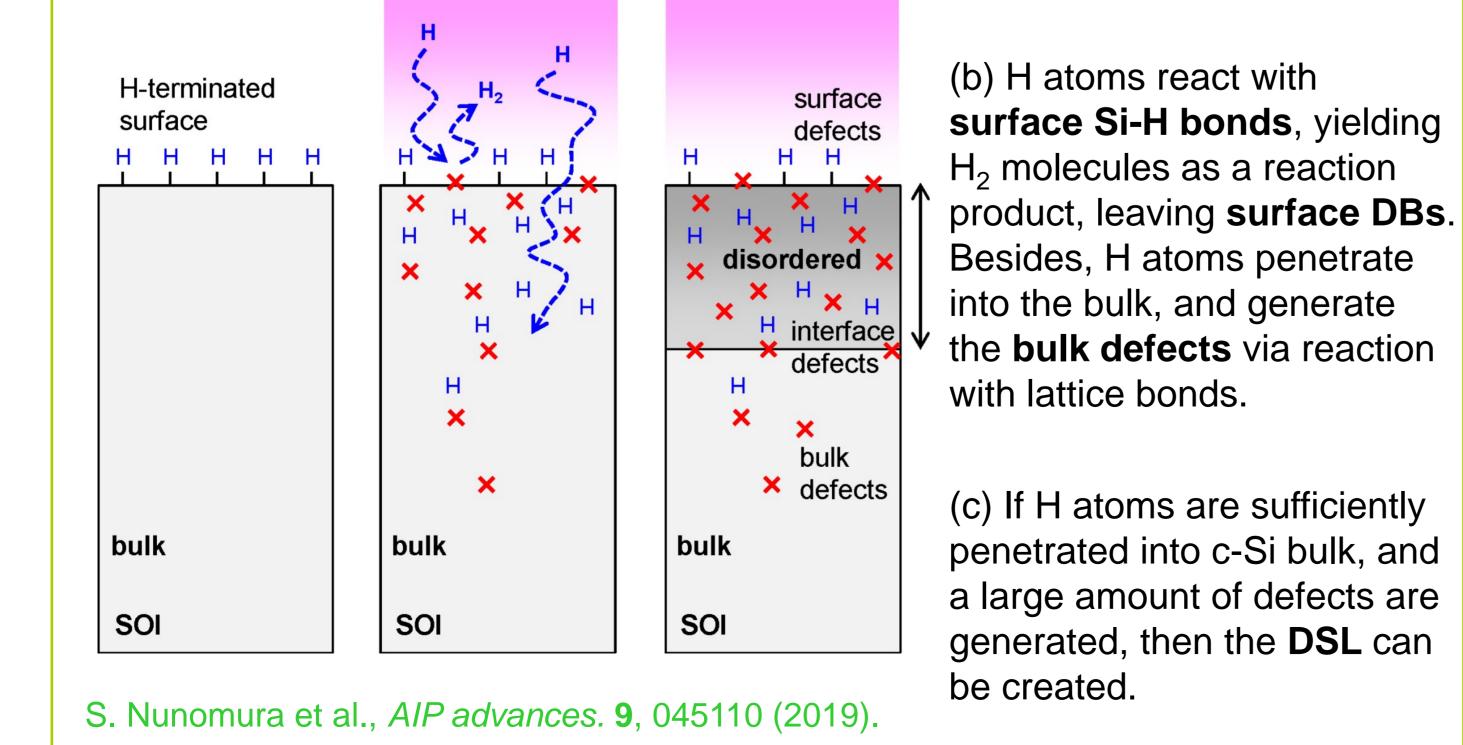
(b) short-∆t (c) long-∆t treatment treatment

(a) Initially, the surface is terminated with H atoms.

- (a)The **DSL** is formed only for long- $\Delta t$  treatment. No DSL formation for short- $\Delta t$  treatment.
- (b) The reduction tendency of  $I_p$  is classified into two groups: low-T and high-T groups.
- In the high-T group, I<sub>p</sub> is decreased once  $\Delta t$  exceeds 10<sup>-4</sup> s.
- In the low-T group, a longer- $\Delta t$ treatment is required for generation of defects, possibly due to impurity adsorption.
  - **Before formation of DSL, the H**induced electronic defects are created.
- S. Nunomura et al., AIP advances. 9, 045110 (2019). S. Nunomura et al., Appl. Phys. Express. 12, 051006 (2019).

#### Summary

The generation and annihilation of H-induced defects in crystalline



silicon has been studied during H<sub>2</sub> plasma treatments, by using in-situ photocurrent measurement and spectroscopic ellipsometry.

- The H-induced defects are generated by a  $H_2$  plasma treatment, and annihilated/recovered by postannealing.
- The generation of defects depends on treatment time and temperature.
- The electronic defects are created before the formation of DSL, i.e., nanometer-scale amorphized surface layer.
- The surface and/or bulk defects are partially recovered, but the DSL is not recovered.

#### Acknowledgements

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